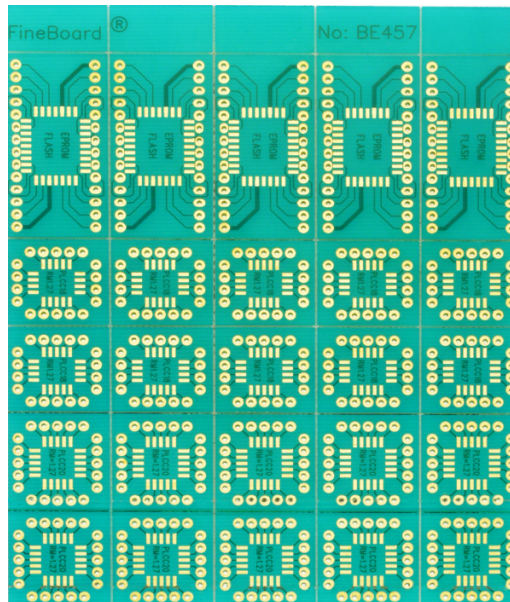


Datenblatt - Artikelnr. BE 457



Suitable for development and experiments with different package types. All adapters could be connected with the pin-headers to a number of different prototyping boards with 2.54mm Hole spacing. The connection between the prototyping board and the SMD Adapter will be made with pin headers.

Material: FR 4 (Epoxy), 1,5mm, 35µ Copper foil, absolutely plane surface with chemical nickel/gold coating. On each prototyping board there are a few adapters available. V-cut allows easy break out of each circuit.

Package Type	Piece/Board	Size (mm)	Pin	Hole spacing (mm)
PLCC18	10	7x5	18	1.27
PLCC20	10	7x7	20	1.27
EPROM-FLASH	5	12x9	32	1.27

Material : Epoxy (FR4), 1.5 mm
Size : 124 x 100 mm
Hole spacing : 2.54 mm
Trace : Refer to picture
Hole diameter : 1.0 mm
Surface : 35 µ copper foil, solder mask, chem. nickel/gold